

# SSC8219GN4

### **P-Channel Enhancement Mode MOSFET**

### > Features

V <sub>DS</sub>	V <sub>GS</sub>	R <sub>DS(ON)</sub> Typ.	l <sub>D</sub>
-16V	+12V	7.8mΩ@-10V	-45A
-100	<u> </u>	10.2mΩ@-4V5	-45/1

# > Description

The SSC8219GN4 is P-Channel enhancement mode MOSFET. Uses trench Technology and design to provide excellent RDSON with low gate charge. This device is suitable for use in DC - DC conversion, power switch and charging circuit.

100% UIS + ΔVDS + Rg Tested!

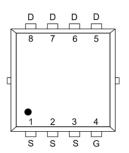
### > Applications

- Inverter
- DC-DC Converter
- Half and Full Bridge Topology
- Motor Drive Control

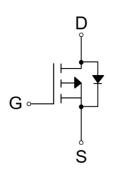
### Ordering Information

Device	Package	Shipping	
SSC8219GN4	PDFN3.3X3.3-8L	5000/Reel	

### Pin configuration



PDFN3.3x3.3-8L (Top View)



**Pin Configuration** 



### **Marking**

(XXYY: Internal Traceability Code)



### ➤ Absolute Maximum Ratings (T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter		Ratings	Unit
V <sub>DSS</sub>	Drain-to-Source Voltage		-16	V
V <sub>GSS</sub>	Gate-to-Source Vol	tage	±12	V
	Continuous Dunin Cumth	T <sub>C</sub> = 25°C	-45	А
l <sub>D</sub>	Continuous Drain Current <sup>b</sup>	T <sub>C</sub> = 100°C	-24	А
I <sub>DM</sub>	Pulsed Drain Curre	ent <sup>b</sup>	-178	А
	Continuous Drain Current <sup>a</sup>	T <sub>A</sub> = 25°C	-16	А
ldsм		T <sub>A</sub> = 70℃	-11.4	А
Б	P <sub>D</sub> Power Dissipation °	T <sub>C</sub> = 25°C	25	W
$P_{D}$	Power Dissipation •	oltage $T_{C} = 25^{\circ}C$ $T_{C} = 100^{\circ}C$ $T_{A} = 25^{\circ}C$ $T_{A} = 70^{\circ}C$ $T_{C} = 25^{\circ}C$ $T_{C} = 100^{\circ}C$ $T_{A} = 25^{\circ}C$ $T_{A} = 70^{\circ}C$ $= 0.5 \text{mH}$ $= 0.5 \text{mH}$ $= 0.5 \text{mH}$	10	W
-	Danie Birchetier	T <sub>A</sub> = 25℃	3.2	W
P <sub>DSM</sub> Po	Power Dissipation <sup>a</sup>	T <sub>A</sub> = 70℃	2	W
I <sub>AS</sub>	Avalanche Current b L = 0.5mH		-19	А
E <sub>AS</sub>	Avalanche Energy <sup>b</sup> L = 0.5mH		90	mJ
TJ	Operation junction temperature		-55 to 150	$^{\circ}$
T <sub>STG</sub>	Storage temperature range		-55 to 150	$^{\circ}$

# ➤ Thermal Resistance Ratings (T<sub>A</sub>=25°C unless otherwise noted)

Symbol	Parameter	Ratings	Unit
R <sub>0JA</sub>	Junction-to-Ambient Thermal Resistance a	40	°C ////
Rejc	Junction-to-Case Thermal Resistance	3.7	°C/W

#### Note:

- a. The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz.copper,in a still air environment with  $T_A$ =25 °C. The value in any given application depends on the user is specific board design. The current rating is based on the t≤10s thermal resistance rating.
- b. Repetitive rating, pulse width limited by junction temperature.
- c. The power dissipation P<sub>D</sub> is based on T<sub>J(MAX)</sub>=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
- d. The maximum current rating is package limited.

SSC-V1.1 www.sscsemi.com Analog Future



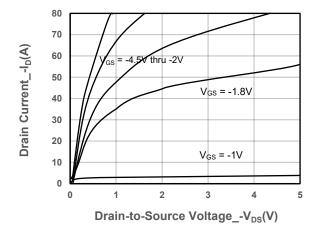


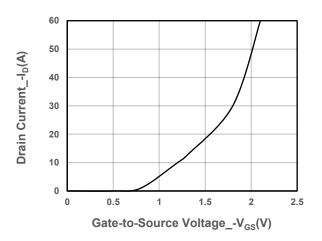
# $\succ$ Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0V, I <sub>D</sub> = -250uA	-16			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250uA$	-0.4	-0.6	-1	V
Drain-Source On-Resistance	Б	V <sub>GS</sub> = -4.5V, I <sub>D</sub> = -4.1A		7.8	10.5	m0
Dialii-Source Oil-Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = -2.5V, I <sub>D</sub> = -3A		10.2	14	mΩ
Zero Gate Voltage Drain Current	loss	V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V			-1	μA
Gate-Source Leak Current	Igss	$V_{GS} = \pm 12V, V_{DS} = 0V$			±100	nA
Forward Voltage	$V_{SD}$	V <sub>GS</sub> = 0V, I <sub>S</sub> =-3A			-1.2	V
Gate Resistance	R <sub>G</sub>	V <sub>DS</sub> = 0V, f = 1MHz		2.5		Ω
Input Capacitance	Cıss	V <sub>DS</sub> = -8V, V <sub>GS</sub> = 0V,		2053		
Output Capacitance	Coss	f = 1MHz		385		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>	I – IIVIOZ		338		
Total Gate Charge	Q <sub>G</sub>	\\ - 45\\\\ - 0\\		38		
Gate to Source Charge	Q <sub>GS</sub>	$V_{GS} = -4.5V, V_{DS} = -8V,$ $I_{D} = -15A$		6		nC
Gate to Drain Charge	Q <sub>GD</sub>	- ID 15A		12		
Turn-on Delay Time	T <sub>D(ON)</sub>			10		
Rise Time	Tr	$V_{GS} = -10V$ , $V_{DS} = -8V$ ,		85		
Turn-off Delay Time	$T_{D(OFF)}$	$I_D = -13A, R_G = 27\Omega$		112		ns
Fall Time	T <sub>f</sub>			110		
Diode Recovery Time	Trr	I <sub>F</sub> =-20A, di/dt=-100A/us		23		ns
Diode Recovery Charge	Qrr	I <sub>F</sub> =-20A, di/dt=-100A/us		14		nC



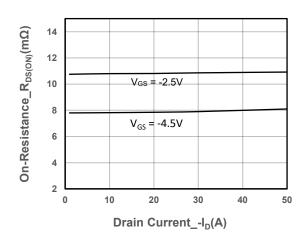
## > Typical Performance Characteristics (T<sub>A</sub>=25℃ unless otherwise noted)

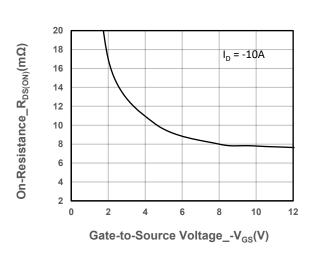




### **Output Characteristics**

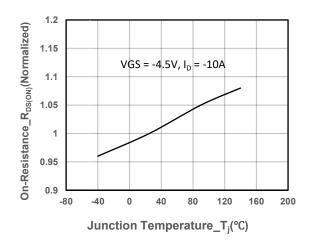
**Transfer Characteristics** 

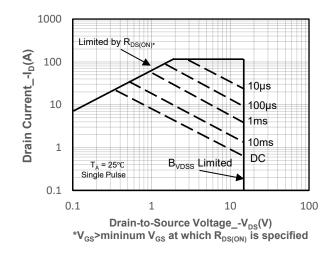




#### On-Resistance vs. Drain Current and Gate Voltag

On-Resistance vs. Gate-to-Source Voltage



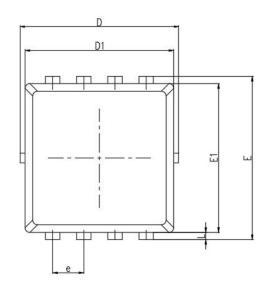


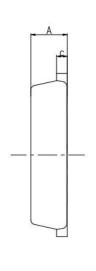
**On-Resistance vs. Junction Temperature** 

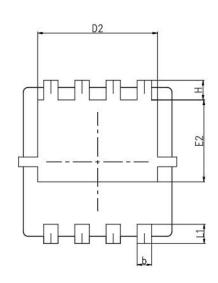
Safe Operating Area vs. Junction-to-Ambient

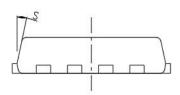


# Package Information









Cumbal	MILL IMETER			
Symbol	Min	Nom	Max	
Α	0.65	0.75	0.9	
b	0.20	0.3	0.40	
С	0.1	1	0.22	
D	3.1	3.3	3.45	
D1	3	3.15	3.2	
D2	2.55	2.5	2.75	
E	3.15	3.3	3.45	
E1	2.9	3.05	3.2	
E2	1.55	1.75	1.95	
е	0.65BSC			
L	0.06	0.15	0.2	
L1	0.25	0.4	0.55	
Н	0.31	0.35	0.6	
S	10°	12°	14°	



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